

# Microprocessor Supervisory Circuit

**ADM1232** 

#### **FEATURES**

Pin-compatible with MAX1232 and Dallas DS1232 Adjustable precision voltage monitor with 4.5 V and 4.75 V options

Adjustable strobe monitor with 150 ms, 600 ms, or 1.2 sec options

No external components Specified from -40°C to +85°C

#### **APPLICATIONS**

Microprocessor systems
Portable equipment
Computers
Controllers
Intelligent instruments
Automotive systems

#### **GENERAL DESCRIPTION**

The ADM1232 is pin-compatible with the MAX1232, DS1232LP, and DS1232. The Analog Devices, Inc., ADM1232 is a microprocessor monitoring circuit that can monitor the following:

- Microprocessor supply voltage
- Whether a microprocessor has locked up
- External interrupts

The ADM1232 is available in four packages: an 8-lead MSOP (RM-8), an 8-lead PDIP (N-8), a 16-lead wide SOIC (RW-16), and an 8-lead narrow SOIC (R-8).

#### **FUNCTIONAL BLOCK DIAGRAM**

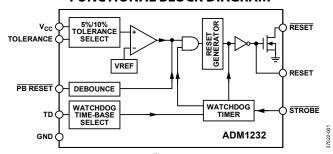


Figure 1.

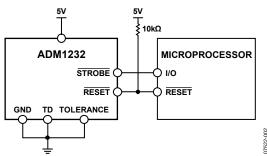


Figure 2. Typical Supply Monitoring Application

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12/08—Rev. B to Rev. C	
Updated Format	Universal
Changes to Table 2	4
Added Thermal Resistance Section	4
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# **SPECIFICATIONS**

 $V_{\text{CC}}$  = full operating range,  $T_{\text{A}}$  =  $T_{\text{MIN}}$  to  $T_{\text{MAX}}$ , unless otherwise noted.

Table 1.

Parameter	Min	Тур	Max	Unit	Test Conditions/Comments
TEMPERATURE	-40		+85	°C	$T_A = T_{MIN}$ to $T_{MAX}$ .
POWER SUPPLY					
Voltage	4.5	5.0	5.5	V	
Current		20	50	μΑ	$V_{IL}$ , $V_{IH}$ = CMOS levels.
		200	500	μΑ	$V_{IL}$ , $V_{IH} = TTL$ levels.
STROBE AND PB RESET INPUTS					
Input High Level	2.0		$V_{cc} + 0.3$	V	
Input Low Level	-0.3		+0.8	V	
INPUT LEAKAGE CURRENT					
(STROBE, TOLERANCE)	-1.0		+1.0	μΑ	
TD		1.6		μΑ	
OUTPUT CURRENT		1.0		μπ	
RESET	8	10		mA	V <sub>CC</sub> is at 4.5 V to 5.5 V.
RESET/RESET	-8	–12		mA	V <sub>CC</sub> is at 4.5 V to 5.5 V.
OUTPUT VOLTAGE	-0	-14		111/	νις 15 αι τ.5 ν το 5.5 ν.
RESET/RESET	V <sub>cc</sub> – 0.5	V <sub>cc</sub> – 0.1		V	When sourcing less than 500 µA, RESET remains within
RESET/RESET	V <sub>CC</sub> – 0.3	V <sub>CC</sub> – 0.1		V	0.5 V of V <sub>CC</sub> on power-down until V <sub>CC</sub> drops below 2.0 V.
					When sinking less than 500 µA, RESET remains within
					0.5 V of GND on power-down until V <sub>CC</sub> drops below 2.0 V.
RESET/RESET High Level			0.4	V	
RESET/RESET Low Level	2.4			V	
1 V OPERATION					
RESET Output Voltage		V <sub>CC</sub> – 0.1		V	When sourcing less than 50 μA.
RESET Output Voltage		0.1		V	When sinking less than 50 µA.
V <sub>CC</sub> TRIP POINT				-	
5%	4.5	4.62	4.74	V	TOLERANCE = GND.
10%	4.25	4.37	4.49	v	TOLERANCE = V <sub>CC</sub> .
CAPACITANCE	25			1	1921302 700
Input (STROBE, TOLERANCE)			5	pF	T <sub>A</sub> = 25°C.
Output (RESET, RESET)			7	pF	$T_A = 25$ °C.
PB RESET				Pi	1 <sub>A</sub> – 23 C.
	20				DD DECET
Time	20			ms	PB RESET must be held low for a minimum of 20 ms to
Delay	1	4	20	ms	guarantee a reset.
RESET ACTIVE TIME	250	610	1000	<b>+</b>	
STROBE	230	010	1000	ms	
	70				
Pulse Width	70	450	252	ns	TD 01/
Timeout Period	62.5	150	250	ms	TD = 0 V.
	250	600	1000	ms	TD = floating.
	500	1200	2000	ms	$TD = V_{CC}$ .
Vcc	10				Cuarante ad bu design
Fall Time	10			μs	Guaranteed by design.
Rise Time	0			μs	Guaranteed by design.
V <sub>CC</sub> FAIL DETECT TO RESET OUTPUT DELAY					RESET and RESET are logically correct.
			50	μs	After V <sub>CC</sub> falls below the set tolerance voltage (see Figure 9).
	250	610	1000	ms	After V <sub>CC</sub> rises above the set tolerance voltage.

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25$ °C unless otherwise noted.

Table 2.

Parameter	Rating
Vcc	5.5 V
Logic Inputs	$-0.3 \text{ V to V}_{CC} + 0.3 \text{ V}$
Storage Temperature Range	−65°C to +150°C
Lead Temperature (Soldering, 10 sec)	300°C
Vapor Phase (60 sec)	215°C
Infrared (15 sec)	220°C
Power Dissipation	
N-8 <sup>1</sup>	1000 mW
RW-16, RM-8 <sup>2</sup>	900 mW
R-8 <sup>2</sup>	900 μW

<sup>&</sup>lt;sup>1</sup> Derate by 13.5 mW/°C above 25°C.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### THERMAL RESISTANCE

 $\theta_{JA}$  is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 3. Thermal Resistance

Package Type	θја	Unit
8-Lead PDIP (N-8)	100	°C/W
16-Lead SOIC_W (RW-16)	73	°C/W
8-Lead MSOP (RM-8)	206	°C/W
8-Lead SOIC_N (R-8)	153	°C/W

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

 $<sup>^2</sup>$  Derate by 12 mW/°C above 25°C.

# PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

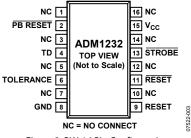


Figure 3. RW-16 Pin Configuration



Figure 4. RM-8 Pin Configuration

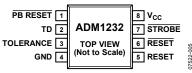


Figure 5. N-8 and R-8 Pin Configuration

**Table 4. Pin Function Descriptions** 

Pir	Pin No.    N-8, R-8,   RW-16   RM-8   Mnemonic		
RW-16			Description
1, 3, 5, 7, 10, 12, 14, 16		NC	No Connection.
2	1	PB RESET	Push-Button Reset Input. This debounced input ignores pulses of less than 1 ms and is guaranteed to respond to pulses greater than 20 ms.
4	2	TD	Time Delay Set. This input allows the user to select the maximum amount of time that the ADM1232 allows the STROBE input to remain inactive—that is, STROBE is not receiving any high-to-low transitions—without forcing the ADM1232 to generate a RESET pulse.  See the Specifications section, Figure 8, and the STROBE Timeout Selection section.
6	3	TOLERANCE	Tolerance Input. This input determines how much the supply voltage is allowed to decrease (as a percentage) before a RESET is asserted. Connect this pin to V <sub>CC</sub> for 10% and to GND for 5%.
8	4	GND	0 V Ground Reference for All Signals.
9	5	RESET	Active High Logic Output. This pin is asserted when any of the following events occurs: V <sub>CC</sub> decreases below the amount specified by the TOLERANCE input; when PB RESET is forced low if there are no high-to-low transitions within the limits set by TD at STROBE; and during power-up.
11	6	RESET	Inverse of RESET. This pin has an open-drain output.
13	7	STROBE	The STROBE input is used to monitor the activity of a microprocessor. If there are no high-to-low transitions within the time specified by TD, a reset is asserted.
15	8	V <sub>CC</sub>	Power Supply Input, 5 V.

#### **CIRCUIT INFORMATION**

#### **PB RESET**

The  $\overline{PB}$  RESET input makes it possible to manually reset a system using either a standard push-button switch or a logic low input. An internal debounce circuit provides glitch immunity when used with a switch, reducing the effects of glitches on the line. The debounce circuit is guaranteed to cause the ADM1232 to assert a reset if  $\overline{PB}$  RESET is brought low for more than 20 ms and is guaranteed to ignore low inputs of less than 1 ms.

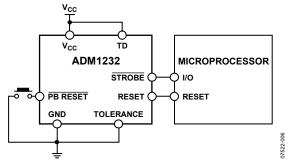
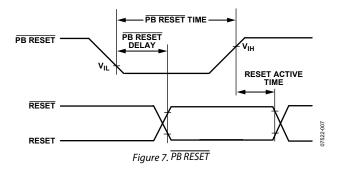


Figure 6. Typical Push-Button Reset Application

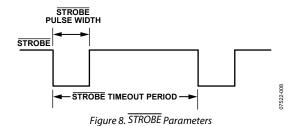


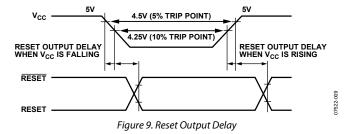
#### **STROBE TIMEOUT SELECTION**

TD (time delay) set is used to set the strobe timeout period. The strobe timeout period is the maximum time between high-to-low transitions that  $\overline{\text{STROBE}}$  accepts before a reset is asserted (see Figure 8). The strobe timeout settings are listed in Table 5.

**Table 5. Strobe Timeout Settings** 

Condition	Min	Тур	Max	Unit
TD = 0 V	62.5	150	250	ms
TD = Floating	250	600	1000	ms
$TD = V_{CC}$	500	1200	2000	ms





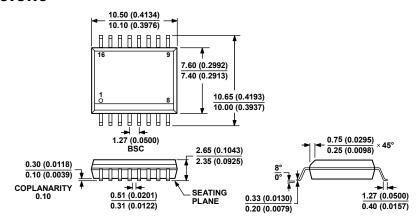
#### **TOLERANCE**

The TOLERANCE input is used to determine the level at which  $V_{\rm CC}$  can vary below 5 V without the ADM1232 asserting a reset. Connecting TOLERANCE to GND selects a -5% tolerance level and causes the ADM1232 to generate a reset if  $V_{\rm CC}$  falls below 4.75 V. If TOLERANCE is connected to  $V_{\rm CC}$ , a -10% tolerance level is selected, which causes the ADM1232 to generate a reset if  $V_{\rm CC}$  falls below 4.5 V. See the parameters for the  $V_{\rm CC}$  trip point in the Specifications section for more information.

#### **RESET AND RESET OUTPUTS**

RESET is capable of sourcing and sinking current, whereas RESET is an open-drain MOSFET that sinks current only. Therefore, it is necessary to pull this output high.

## **OUTLINE DIMENSIONS**



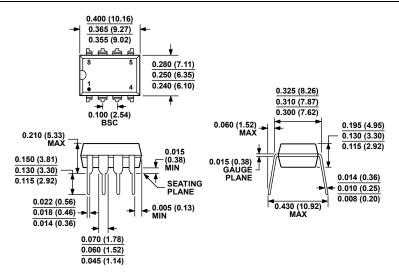
# COMPLIANT TO JEDEC STANDARDS MS-013-AA CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 10. 16-Lead Standard Small Outline Package [SOIC\_W]
Wide Body
(RW-16)
Dimensions shown in millimeters and (inches)

<u>3.20</u> 3.00 2.80 R R R 5.15 3.20 4.90 3.00 4.65 0.95 0.85 1.10 MAX 0.75 0.00 0.22 COPLANARITY 0.10 SEATING PLANE

#### COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 11. 8-Lead Mini Small Outline Package [MSOP] (RM-8) Dimensions shown in millimeters

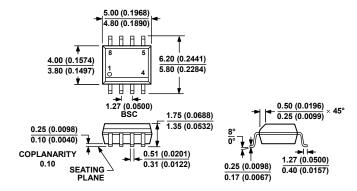


#### COMPLIANT TO JEDEC STANDARDS MS-001

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 12. 8-Lead Plastic Dual In-Line Package [PDIP] Narrow Body (N-8)

Dimensions shown in inches and (millimeters)



COMPLIANT TO JEDEC STANDARDS MS-012-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 13. 8-Lead Standard Small Outline Package [SOIC\_N] Narrow Body (R-8)

Dimensions shown in millimeters and (inches)

#### **ORDERING GUIDE**

	Temperature		Package	
Model	Range	Package Description	Options	Branding
ADM1232ARM	−40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	M2A
ADM1232ARM-REEL	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	M2A
ADM1232ARM-REEL7	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	M2A
ADM1232ARMZ <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	M4W
ADM1232ARMZ-REEL <sup>1</sup>	-40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	M4W
ADM1232ARMZ-REEL7 <sup>1</sup>	−40°C to +85°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	M4W
ADM1232AN	−40°C to +85°C	8-Lead Plastic Dual In-Line Package [PDIP]	N-8	
ADM1232ANZ <sup>1</sup>	-40°C to +85°C	8-Lead Plastic Dual In-Line Package [PDIP]	N-8	
ADM1232ARW	−40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_W], Wide Body	RW-16	
ADM1232ARW-REEL	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_W], Wide Body	RW-16	
ADM1232ARW-REEL7	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_W], Wide Body	RW-16	
ADM1232ARWZ <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_W], Wide Body	RW-16	
ADM1232ARWZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_W], Wide Body	RW-16	
ADM1232ARWZ-REEL7 <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_W], Wide Body	RW-16	
ADM1232ARN	−40°C to +85°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADM1232ARN-REEL	-40°C to +85°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADM1232ARN-REEL7	−40°C to +85°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADM1232ARNZ <sup>1</sup>	-40°C to +85°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADM1232ARNZ-REEL <sup>1</sup>	-40°C to +85°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADM1232ARNZ-REEL7 <sup>1</sup>	-40°C to +85°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	

 $<sup>^{1}</sup>$  Z = RoHS Compliant Part.

**NOTES** 

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